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Silicon Carbide (SiC) Module – EliteSiC Power Module for Traction Inverter, Single-Side Cooling, 2.6 mohm, 1200 V, Half-Bridge, 90° Power Tabs



AHPM15-CDA MODULE CASE MODHG



NVVR26A120M1WST

Product Description

The NVVR26A120M1WST is part of the EliteSiC power module for traction inverter, a revolutionary high mobility compound semiconductor product family that offers increased performance, better efficiency, and higher power density in similar and highly compatible packaging solutions. The module integrates 1200 V SiC MOSFET in a half-bridge configuration. To enhance reliability and thermal performance, sintering technology is applied for die attach. The module is designed to meet the AQG324 standard.

Features

- Ultra Low R_{DS(on)}
- Aluminum Nitride Isolator
- Ultra-low Stray Inductance ~ 7.1 nH
- T_{vi.Max} = 175°C for Continuous Operation
- Automotive Grade SiC MOSFET Chip Technologies
- Sintered Die Technology for High Reliability Performance
- Automotive Module AQG324 Compliant
- PPAP Capable

Applications

• Automotive EV/HEV- Traction Inverter





ORDERING INFORMATION

Device	Package	Shipping
NVVR26A120M1WST	A1HPM	Tube

1



Figure 1. Pin Description

PIN FUNCTION DESCRIPTIONS

Pin No.	Pin Name	Pin Functional Description
1	Ν	Negative Power Terminal
2	Р	Positive Power Terminal
3	D1	High Side MOSFET (Q1) Drain Sense
4	N/C	No Connection
5	S1	High Side MOSFET (Q1) Source
6	G1	High Side MOSFET (Q1) Gate
7	N/C	No Connection
8	N/C	No Connection
9	AC	Phase Output
10	NTC1	NTC 1
11	S2	Low Side MOSFET (Q2) Source
12	G2	Low Side MOSFET (Q2) Gate
13	NTC2	NTC 2
14	NTC_COM	NTC common
15	D2	Low Side MOSFET (Q2) Drain Sense

Materials

DBC Substrate: AlN isolated substrate, basic isolation, and copper on both sides

Lead frame: Copper, with tin electro-plating

Flammability Information

All materials present in the power module meet UL flammability rating class 94V-0

MODULE CHARACTERISTICS (T_{vj} = 25°C, Unless Otherwise Specified)

Symbol	Parameter	Rating	Unit
T _{vj}	Operating Junction Temperature	-40 to 175	°C
T _{STG}	Storage Temperature Range	-40 to 125	°C
V _{ISO}	Isolation Voltage (AC, 50 Hz, 5 s)	4200	V
Ls _{DS}	Stray Inductance	7.1	nH
R _{DD'+SS'}	Module Lead Resistance, Terminal to Chip	0.3	mΩ
G	Module Weight	48	g
CTI	Comparative Tracking Index	>600	-
Creepage	Minimum: Terminal to Terminal	5.0	mm
Clearance	Minimum: (Note 1) Terminal to Terminal	3.2	mm
М	M5 DIN 439B Screws for Module Terminals, Max. Torque	2.2	Nm

1. Verified by design/characterization, not tested.

ABSOLUTE MAXIMUM RATINGS (Tvj = 25°C, Unless Otherwise Specified)

Symbol	Parameter	Rating	Unit
V _{DS}	Drain-Source Voltage	1200	V
V _{GS}	Gate-Source Voltage	+25/-10	V
I _{DS}	Continuous DC Current, V _{GS} = 20 V, T _{vj} = 175°C, T _F = 65°C @ 10LPM, using Ref. Heatsink (Note 2)	400	A
I _{DS.pulsed}	Pulsed Drain–Source Current, V_{GS} = 20 V, limited by $T_{vj.Max}$	800	А
I _{SD.BD}	DC Current in Body Diode, V _{GS} = –5 V, T _{vj} = 175°C, T _F = 65°C @ 10LPM, using Ref. Heatsink (Note 2)	270	A
I _{SD.pulsed}	Pulsed Body Diode Current, V_{GS} =–5 V, limited by $T_{vj.Max}$	800	А
Ptot	Total Power Dissipation T _{vj.Max} = 175°C, T _F = 65°C, Ref. Heatsink (typ)	1000	W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 2. Verified by design / not by test.

	Parameter	r Conditions		Min	Тур	Max	Unit
R _{DS(ON)}	Drain-to-Source On Resistance (Terminal)	V _{GS} = 20V, I _D = 400	A $T_{vj} = 25^{\circ}C$ $T_{vj} = 175^{\circ}C$	-	2.6 4.6	-	mΩ
V _{GS(TH)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 150 \text{ mA}$		2.1	3.2	-	V
9 _{fs}	Forward Transconductance	V _{DS} = 10 V, I _D = 400	A	-	170	-	S
Q _G	Total Gate Charge	$V_{GS} = -5/+20 \text{ V}, \text{ V}_{DS}$	_S = 800 V, I _D = 400 A	-	1.75	_	μC
R _{g.int}	Internal Gate Resistance			-	2.1	-	Ω
C _{iss}	Input Capacitance	V_{DS} = 800 V, V_{GS} =	0 V, f = 100 kHz	-	31.7	-	nF
C _{oss}	Output Capacitance			-	2.2	-	nF
C _{rss}	Reverse Transfer Capacitance			-	0.22	-	nF
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} = 0 V, V _{DS} = 12	$\begin{array}{ll} 200 \text{ V} & T_{vj} = 25^\circ \text{C} \\ T_{vj} = 175^\circ \text{C} \end{array}$	-	_ 13.1	250 -	μΑ
I _{GSS}	Gate-Source Leakage Current	V_{GS} = 20/–5 V, V_{DS}	= 0 V			±700	nA
T _{d.on}	Turn On Delay, Inductive Load	I_{DS} = 400 A, V_{DS} = 800 V, V_{GS} = +20/–5 V, Bg.on = 3 Q	T _{vj} = 25°C T.:: = 175°C	-	125 115	-	ns
Tr	Rise Time, Inductive Load	$I_{DS} = 400 \text{ A}, V_{DS} = 800 \text{ V}, V_{GS} = +20/-5 \text{ V}, Rg.on = 3\Omega$	T _{vj} = 25°C T _{vj} = 175°C	_	59 54	_	ns
T _{d.off}	Turn Off Delay, Inductive Load	$\begin{array}{l} {\sf I}_{DS} = 400 \; {\sf A}, \\ {\sf V}_{DS} = 800 \; {\sf V}, \\ {\sf V}_{GS} = +20/{-5} \; {\sf V}, \\ {\sf Rg.off} = 1 \; \Omega \end{array}$	T _{vj} = 25°C, T _{vj} = 175°C	-	220 228	-	ns
Τ _f	Fall Time, Inductive Load	$\begin{split} & I_{DS} = 400 \text{ A}, \\ & V_{DS} = 800 \text{ V}, \\ & V_{GS} = +20/{-5} \text{ V}, \\ & \text{Rg.off} = 1 \ \Omega \end{split}$	T _{vj} = 25°C T _{vj} = 175°C	-	51 61	-	ns
E _{ON}	Turn-On Switching Loss (including diode reverse recovery loss)	$\begin{array}{l} I_{DS} = 400 \text{ A}, \\ V_{DS} = 800 \text{ V}, \\ V_{GS} = +20/{-5} \text{ V}, \\ \text{Ls} = 17 \text{ nH}, \\ \text{Rg.on} = 3\Omega \end{array}$	$\begin{array}{l} {\rm di/dt} = 8.4 \; {\rm A/ns}, \\ {\rm T}_{vj} = 25^{\circ}{\rm C} \\ {\rm di/dt} = 9.7 \; {\rm A/ns}, \\ {\rm T}_{vj} = 175^{\circ}{\rm C} \end{array}$	_	26 28	_	mJ
E _{OFF}	Turn-Off Switching Loss	$\begin{array}{l} I_{DS} = 400 \text{A}, \\ V_{DS} = 800 \text{ V}, \\ V_{GS} = +20 / -5 \text{ V}, \\ \text{Ls} = 17 \text{ nH}, \\ \text{Rg.off} = 1 \ \Omega \end{array}$	$\begin{array}{l} dv/dt = 19.8 \; V/ns, \\ T_{vj} = 25^{\circ}C \\ dv/dt = 16.8 \; V/ns, \\ T_{vj} = 175^{\circ}C \end{array}$	-	14 17	-	mJ
E _{sc}	Short Circuit Energy Withstand	V _{GS} = 20 V, V _{DS} = 8	$\begin{array}{ll} 300 \text{ V} & T_{vj} = 25^\circ \text{C} \\ T_{vj} = 175^\circ \text{C} \end{array}$	-	12 11	_	J

Conditions Min Max Unit Parameters Тур $\begin{array}{l} T_{vj} = 25^\circ C \\ T_{vj} = 175^\circ C \end{array}$ Diode Forward Voltage $V_{GS} = -5 \text{ V}, \text{ I}_{SD} = 400 \text{ A}$ 3.8 v V_{SD} _ _ (Terminal) 3.3 $I_{SD} = 400 \text{ A},$ $V_{R} = 800 \text{ V},$ $V_{GS} = -5 \text{ V},$ Ls = 17 nH, E_{rr} Reverse Recovery Energy di/dt = 8.4 A/ns, mJ $T_{vj} = 25^{\circ}C$ di/dt = 9.7 A/ns, $T_{vj} = 175^{\circ}C$ 0.4 _ _ 2.1 Rg.on = 3 Ω **Recovered Charge** I_{SD} = 400 A, Q_{RR} μC T_{vj} = 25°C $V_{R}^{-} = 800 V,$ 2.3 $V_{GS} = -5 V$, Rg.on = 3 Ω _ _ $T_{vj} = 175^{\circ}C$ 8.6 $I_{SD} = 400 \text{ A},$ $V_{R} = 800 \text{ V},$ $V_{GS} = -5 \text{ V},$ I_{RR} Peak Reverse Recovery Current А $T_{vj} = 25^{\circ}C$ 527 _ _ Rg.on = 3 Ω $T_{vj} = 175^{\circ}C$ 650

BODY DIODE CHARACTERISTICS (T $_{vj}$ = 25°C, Unless Otherwise Specified)

NTC SENSOR CHARACTERISTICS (T_{vj} = 25° C, Unless Otherwise Specified)

	Parameters	Conditions Min Typ		Max	Unit	
R25	Rated Resistance	Tc = 25°C	-	10	-	kΩ
$\Delta R/R$	Deviation of R100	Tc = 100°C, R100 = 877 Ω	-3	-	+3	%
P25	Power Dissipation	Tc = 25°C	-	-	125	mW
B25/85	B-Value	R = R25 exp [B25/85 (1/T-1/298)]	-1%	3610	+1%	К

THERMAL CHARACTERISTICS

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
$R_{th,J-C}$	FET Junction to Case		-	0.025	0.028	°C/W
R _{th,J-F}	FET Junction to Fluid	$R_{th},$ Junction to Fluid, 10 L/min, 65°C, 50/50 EGW, Ref. Heatsink	-	0.11	-	°C/W









Figure 21. Gate Charge vs. Gate-Source





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AHPM15-CDA MODULE CASE MODHG ISSUE A

DATE 22 SEP 2021



GENERIC MARKING DIAGRAM*

- ZZZ = Assembly Lot Code
 - T = Assembly & Test Location
 - = Year
- WW = Work Week
- NNNN = Serial Number

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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